

**ON Semiconductor®** 

# FDD9409L-F085 N-Channel Logic Level PowerTrench<sup>®</sup> MOSFET 40 V, 90 A, 2.6 m $\Omega$

## Features

- Typical  $R_{DS(on)}$  = 2.1 m $\Omega$  at  $V_{GS}$  = 10V,  $I_D$  = 80 A
- Typical Q<sub>g(tot)</sub> = 52 nC at V<sub>GS</sub> = 10V, I<sub>D</sub> = 80 A
- UIS Capability
- RoHS Compliant
- Qualified to AEC Q101

## Applications

- Automotive Engine Control
- PowerTrain Management
- Solenoid and Motor Drivers
- Electronic Steering
- Integrated Starter/Alternator
- Distributed Power Architectures and VRM
- Primary Switch for 12V Systems

## **MOSFET Maximum Ratings** $T_J = 25^{\circ}C$ unless otherwise noted.

Symbol	Parameter		Ratings	Units
V <sub>DSS</sub>	Drain-to-Source Voltage		40	V
V <sub>GS</sub>	Gate-to-Source Voltage		±20	V
	Drain Current - Continuous (V <sub>GS</sub> =10) (Note 1)	T <sub>C</sub> =25°C	90	•
D	Pulsed Drain Current	T <sub>C</sub> = 25°C	See Figure 4	Α
E <sub>AS</sub>	Single Pulse Avalanche Energy	(Note 2)	33.7	mJ
<b>D</b>	Power Dissipation		150	W
P <sub>D</sub>	Derate Above 25°C		1	W/ºC
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Temperature		-55 to + 175	°C
$R_{\theta JC}$	Thermal Resistance, Junction to Case		1	°C/W
$R_{\theta JA}$	Maximum Thermal Resistance, Junction to Ambient	(Note 3)	52	°C/W

G

S

D-PAK

(TO-252)

### Notes:

- 1: Current is limited by bondwire configuration.
- 2: Starting T<sub>J</sub> = 25°C, L = 15uH, I<sub>AS</sub> = 67A, V<sub>DD</sub> = 40V during inductor charging and V<sub>DD</sub> = 0V during time in avalanche. 3:  $R_{0,JA}$  is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder
- 3: R<sub>0JA</sub> is the sum of the junction-to-case and case-to-ambient thermal resistance, where the case thermal reference is defined as the solder mounting surface of the drain pins. R<sub>0JC</sub> is guaranteed by design, while R<sub>0JA</sub> is determined by the board design. The maximum rating presented here is based on mounting on a 1 in<sup>2</sup> pad of 2oz copper.

## Package Marking and Ordering Information

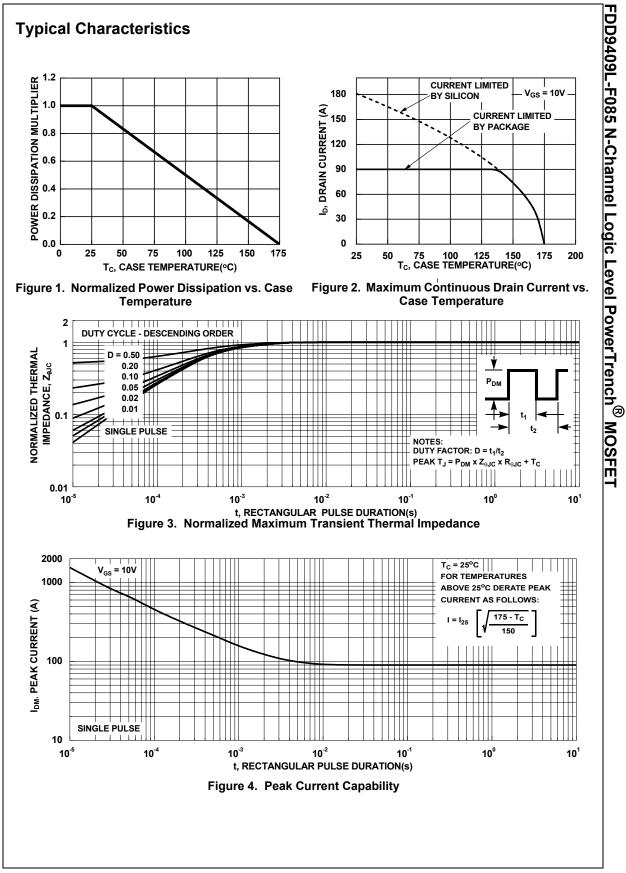
FDD9409L FDD9409L-F085 D-PAK(TO-252) 13" 16mm	2500units

D

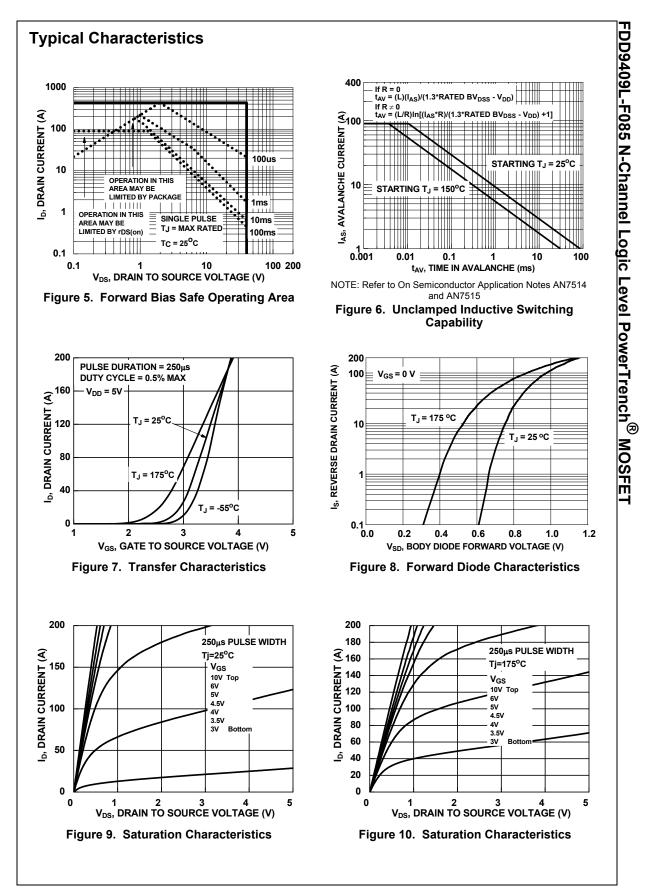


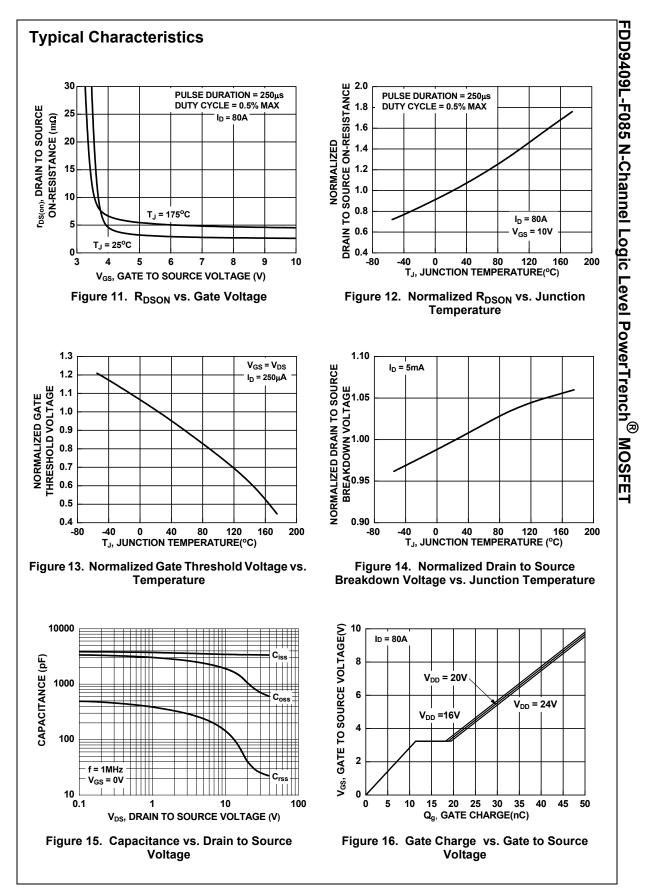
Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Units
Off Cha	aracteristics						
B <sub>VDSS</sub>	Drain-to-Source Breakdown Voltage	I <sub>D</sub> = 250μA, V <sub>GS</sub> = 0V		40	-	-	V
I <sub>DSS</sub>	Drain-to-Source Leakage Current	V <sub>DS</sub> =40V,	T <sub>J</sub> = 25 <sup>o</sup> C	-	-	1	μA
		$V_{GS} = 0V$	$T_{\rm J} = 175^{\rm o}C$ (Note 4)	-	-	1	mA
I <sub>GSS</sub>	Gate-to-Source Leakage Current	$V_{GS} = \pm 20V$		-	-	±100	nA
On Cha	racteristics						
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	V <sub>GS</sub> = V <sub>DS</sub> , I <sub>D</sub> = 250μA		1.0	1.8	3.0	V
		I <sub>D</sub> = 80A, V <sub>0</sub>	<sub>GS</sub> = 4.5V	-	3.0	4.4	mΩ
R <sub>DS(on)</sub>	Drain to Source On Resistance	I <sub>D</sub> = 80A,	T <sub>J</sub> = 25 <sup>o</sup> C	-	2.1	2.6	mΩ
		V <sub>GS</sub> = 10V	$T_{\rm J}$ = 175°C (Note 4)	-	3.7	4.6	mΩ
C <sub>iss</sub> C <sub>oss</sub> C <sub>rss</sub> R <sub>g</sub>	Input Capacitance Output Capacitance Reverse Transfer Capacitance Gate Resistance Table Outputs Observed	V <sub>DS</sub> = 20V, V <sub>GS</sub> = 0V, f = 1MHz f = 1MHz			3360 1080 42 2.2		pF pF pF Ω
Q <sub>g(ToT)</sub>	Total Gate Charge	$V_{GS} = 0$ to 1	• • • • • • • • •	-	52	68	nC
Q <sub>g(th)</sub>	Threshold Gate Charge	V <sub>GS</sub> = 0 to 2	V I <sub>D</sub> = 80A	-	7	-	nC
Q <sub>gs</sub>	Gate-to-Source Gate Charge Gate-to-Drain "Miller" Charge		-	-	11 8	-	nC nC
Q <sub>gd</sub> Switchi	ng Characteristics				0		
t <sub>on</sub>	Turn-On Time	$V_{DD}$ = 20V, I <sub>D</sub> = 80A, V <sub>GS</sub> = 10V, R <sub>GEN</sub> = 6Ω		-	-	47	ns
t <sub>d(on)</sub>	Turn-On Delay			-	10	-	ns
t <sub>r</sub>	Rise Time			-	13	-	ns
t <sub>d(off)</sub>	Turn-Off Delay			-	36	-	ns
t <sub>f</sub>	Fall Time Turn-Off Time			-	10	- 70	ns
t <sub>off</sub> Drain-S	Source Diode Characteristics			-	-	70	ns
		I <sub>SD</sub> =80A, V	$(z_{z} = 0)/$	-	-	1.25	V
	Source-to-Drain Diode Voltage	I <sub>SD</sub> = 40A, V		-	-	1.25	V
V <sub>SD</sub>		$I_{SD} = 40A, V_{GS} = 0V$ $I_F = 80A, dI_{SD}/dt = 100A/\mu s$					-
V <sub>SD</sub>	Reverse-Recovery Time	$I_{r} = 80A$ d	$l_{eD}/dt = 100 A/us$	-	59	77	ns

FDD9409L-F085 N-Channel Logic Level PowerTrench<sup>®</sup> MOSFET



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